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July 2007

)S90CF384A/DS90CF364A +3.3V LVDS Receiver 24-Bit-Color Flat Panel Display(ink—65 MHz,+3.3V LVDS Receiver 18-Bit-Color Flat Panel Display (FPD) Link—

–65 MHz

DS90CF384A/DS90CF364A +3.3V LVDS Receiver 24-Bit Flat Panel Display (FPD) Link —65 MHz, +3.3V LVDS Receiver 18-Bit Flat Panel Display (FPD) Link—65 MHz

General Description

The DS90CF384A receiver converts the four LVDS data streams (Up to 1.8 Gbps throughput or 227 Megabytes/sec bandwidth) back into parallel 28 bits of CMOS/TTL data (24 bits of RGB and 4 bits of Hsync, Vsync, DE and CNTL). Also available is the DS90CF364A that converts the three LVDS data streams (Up to 1.3 Gbps throughput or 170 Megabytes/ sec bandwidth) back into parallel 21 bits of CMOS/TTL data (18 bits of RGB and 3 bits of Hsync, Vsync and DE). Both Receivers' outputs are Falling edge strobe. A Rising edge or Falling edge strobe transmitter (DS90C383A/DS90C363A) will interoperate with a Falling edge strobe Receiver without any translation logic.

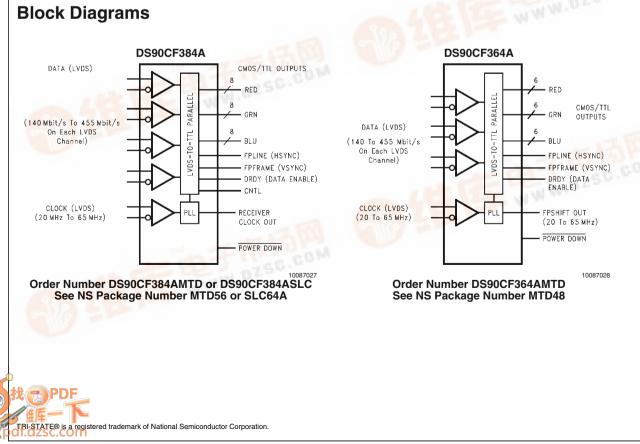
The DS90CF384A / DS90CF364A devices are enhanced over prior generation receivers and provided a wider data valid time on the receiver output.

The DS90CF384A is also offered in a 64 ball, 0.8mm fine pitch ball grid array (FBGA) package which provides a 44 % reduction in PCB footprint compared to the 56L TSSOP package.

This chipset is an ideal means to solve EMI and cable size problems associated with wide, high speed TTL interfaces.

Features

- 20 to 65 MHz shift clock support
- 50% duty cycle on receiver output clock
- Best-in-Class Set & Hold Times on RxOUTPUTs
- Rx power consumption <142 mW (typ) @65MHz Grayscale
- Rx Power-down mode <200µW (max)</p>
- ESD rating >7 kV (HBM), >700V (EIAJ)
- Supports VGA, SVGA, XGA and Dual Pixel SXGA.
- PLL requires no external components
- Compatible with TIA/EIA-644 LVDS standard
- Low profile 56-lead or 48-lead TSSOP package
- DS90CF384A is also available in a 64 ball, 0.8mm fine pitch ball grid array (FBGA) package



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| Supply Voltage (V _{CC}) | –0.3V to +4V |
|-----------------------------------|-----------------------------------|
| CMOS/TTL Input Voltage | –0.3V to (V _{CC} + 0.3V) |
| CMOS/TTL Output Voltage | -0.3V to (V _{CC} + 0.3V) |
| LVDS Receiver Input Voltage | –0.3V to (V _{CC} + 0.3V) |
| Junction Temperature | +150°C |
| Storage Temperature | –65°C to +150°C |
| Lead Temperature | |
| (Soldering, 4 sec) | +260°C |
| Solder Reflow Temperature | |
| (20 sec for FBGA) | +220°C |
| Maximum Package Power | |
| Dissipation Capacity @ 25°C | |
| MTD56 (TSSOP) Package: | |
| DS90CF384A | 1.61 W |
| MTD48 (TSSOP) Package: | |
| DS90CF364A | 1.89 W |
| | |

| SLC (FBGA) Package: | |
|-----------------------|------------------------|
| DS90CF384A | 2.0 W |
| Package Derating: | |
| DS90CF384AMTD | 12.4 mW/°C above +25°C |
| DS90CF364AMTD | 15 mW/°C above +25°C |
| DS90CF384ASLC | 10.2 mW/°C above +25°C |
| ESD Rating | |
| (HBM, 1.5 kΩ, 100 pF) | > 7 kV |
| (EIAJ, 0Ω, 200 pF) | > 700V |
| | |

Recommended Operating Conditions

| | Min | Nom | Max | Units |
|---|-----|-----|-----|------------------|
| Supply Voltage (V _{CC}) | 3.0 | 3.3 | 3.6 | V |
| Operating Free Air | | | | |
| Temperature (T _A) | -10 | +25 | +70 | °C |
| Receiver Input Range | 0 | | 2.4 | V |
| Supply Noise Voltage (V _{CC}) | | | 100 | mV _{PP} |

Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

| Symbol | Parameter | Conditions | 5 | Min | Тур | Max | Units |
|-----------------|-----------------------------------|---|---|------|-------------|-----------------|-------|
| CMOS/T | L DC SPECIFICATIONS (For Power D | own Pin) | | | · · · · · · | | |
| V _{IH} | High Level Input Voltage | | | 2.0 | | V _{cc} | V |
| V _{IL} | Low Level Input Voltage | | | GND | | 0.8 | V |
| V _{CL} | Input Clamp Voltage | I _{CL} = -18 mA | | | -0.79 | -1.5 | V |
| I _{IN} | Input Current | V _{IN} = 0.4V, 2.5V or V _{CC} | | | +1.8 | +10 | μA |
| | | V _{IN} = GND | V _{IN} = GND | | | | μA |
| CMOS/T | L DC SPECIFICATIONS | | | | | | |
| V _{OH} | High Level Output Voltage | I _{OH} = -0.4 mA | | 2.7 | 3.3 | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2 mA | | 0.06 | 0.3 | V | |
| I _{OS} | Output Short Circuit Current | $V_{OUT} = 0V$ | | -60 | -120 | mA | |
| LVDS RE | CEIVER DC SPECIFICATIONS | | | | | | |
| V _{TH} | Differential Input High Threshold | V _{CM} = +1.2V | | | +100 | mV | |
| V _{TL} | Differential Input Low Threshold | | | -100 | | | mV |
| I _{IN} | Input Current | $V_{IN} = +2.4V, V_{CC} = 3.6V$ | $V_{\rm IN} = +2.4 V, V_{\rm CC} = 3.6 V$ | | | ±10 | μA |
| | | $V_{IN} = 0V, V_{CC} = 3.6V$ | $V_{IN} = 0V, V_{CC} = 3.6V$ | | | ±10 | μA |
| RECEIVE | ER SUPPLY CURRENT | | | | | | |
| ICCRW | Receiver Supply Current | C _L = 8 pF, | f = 32.5 MHz | | 49 | 65 | mA |
| | Worst Case | Worst Case Pattern, | f = 37.5 MHz | | 53 | 70 | mA |
| | | DS90CF384A <i>(Figures 1, 4)</i> | f = 65 MHz | | 81 | 105 | mA |
| ICCRW | Receiver Supply Current | C _L = 8 pF, | f = 32.5 MHz | | 49 | 55 | mA |
| | Worst Case | Worst Case Pattern, | f = 37.5 MHz | | 53 | 60 | mA |
| | | DS90CF364A <i>(Figures 1, 4)</i> | f = 65 MHz | | 78 | 90 | mA |

| Symbol | Parameter | Condition | Conditions Min | | | | Units |
|--------|--------------------------|--------------------------|----------------------------------|---|----|----|-------|
| ICCRG | Receiver Supply Current, | C _L = 8 pF, | f = 32.5 MHz | | 28 | 45 | mA |
| | 16 Grayscale | 16 Grayscale Pattern, | f = 37.5 MHz | | 30 | 47 | mA |
| | | (Figures 2, 3, 4) | f = 65 MHz | | 43 | 60 | mA |
| ICCRZ | Receiver Supply Current | Power Down = Low | | 2 | 10 | 55 | μA |
| | Power Down | Receiver Outputs Stay Lo | Receiver Outputs Stay Low during | | | | |
| | | Power Down Mode | | | | | |

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

Note 2: Typical values are given for V_{CC} = 3.3V and T_{A} = +25C.

Note 3: Current into device pins is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to ground unless otherwise specified (except V_{OD} and ΔV_{OD}).

Receiver Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified

| Symbol | Parameter | | Min | Тур | Max | Units |
|--------|---|-------------|-------|-------|-------|-------|
| CLHT | CMOS/TTL Low-to-High Transition Time (Figure 4) | | | 2 | 5 | ns |
| CHLT | CMOS/TTL High-to-Low Transition Time (Figure 4) | | | 1.8 | 5 | ns |
| RSPos0 | Receiver Input Strobe Position for Bit 0 (Figure 11, Figure 12) | f = 25 MHz | 1.20 | 1.96 | 2.82 | ns |
| RSPos1 | Receiver Input Strobe Position for Bit 1 | | 6.91 | 7.67 | 8.53 | ns |
| RSPos2 | Receiver Input Strobe Position for Bit 2 | | 12.62 | 13.38 | 14.24 | ns |
| RSPos3 | Receiver Input Strobe Position for Bit 3 | | 18.33 | 19.09 | 19.95 | ns |
| RSPos4 | Receiver Input Strobe Position for Bit 4 | | 24.04 | 24.80 | 25.66 | ns |
| RSPos5 | Receiver Input Strobe Position for Bit 5 | | 29.75 | 30.51 | 31.37 | ns |
| RSPos6 | Receiver Input Strobe Position for Bit 6 | 35.46 | 36.22 | 37.08 | ns | |
| RSPos0 | Receiver Input Strobe Position for Bit 0 (Figure 11, Figure 12) | f = 65 MHz | 0.7 | 1.1 | 1.4 | ns |
| RSPos1 | Receiver Input Strobe Position for Bit 1 | | 2.9 | 3.3 | 3.6 | ns |
| RSPos2 | Receiver Input Strobe Position for Bit 2 | | 5.1 | 5.5 | 5.8 | ns |
| RSPos3 | Receiver Input Strobe Position for Bit 3 | | 7.3 | 7.7 | 8.0 | ns |
| RSPos4 | Receiver Input Strobe Position for Bit 4 | | 9.5 | 9.9 | 10.2 | ns |
| RSPos5 | Receiver Input Strobe Position for Bit 5 | | 11.7 | 12.1 | 12.4 | ns |
| RSPos6 | Receiver Input Strobe Position for Bit 6 | | 13.9 | 14.3 | 14.6 | ns |
| RSKM | RxIN Skew Margin (Note 4) (Figure 13) | f = 25 MHz | 750 | | | ps |
| | | f = 65 MHz | 500 | | | ps |
| RCOP | RxCLK OUT Period (Figure 5) | | 15 | Т | 50 | ns |
| RCOH | RxCLK OUT High Time (Figure 5) | f = 65 MHz | 5.0 | 7.6 | 9.0 | ns |
| RCOL | RxCLK OUT Low Time (Figure 5) | | 5.0 | 6.3 | 9.0 | ns |
| RSRC | RxOUT Setup to RxCLK OUT (Figure 5) | | 4.5 | 7.3 | | ns |
| RHRC | RxOUT Hold to RxCLK OUT (Figure 5) | | 4.0 | 6.3 | | ns |
| RCCD | RxCLK IN to RxCLK OUT Delay @ 25°C, V _{CC} = 3.3V | (Figure 6) | 3.5 | 5.0 | 7.5 | ns |
| RPLLS | Receiver Phase Lock Loop Set (Figure 7) | | | | 10 | ms |
| RPDD | Receiver Power Down Delay (Figure 10) | | | | 1 | μs |

Note 4: Receiver Skew Margin is defined as the valid data sampling region at the receiver inputs. This margin takes into account the DS90C383B transmitter pulse positions (min and max) and the receiver input setup and hold time (internal data sampling window - RSPos). The RSKM will change when different transmitters are used. This margin allows for LVDS interconnect skew, inter-symbol interference (both dependent on type/length of cable), and clock jitter (less than 250 ps).



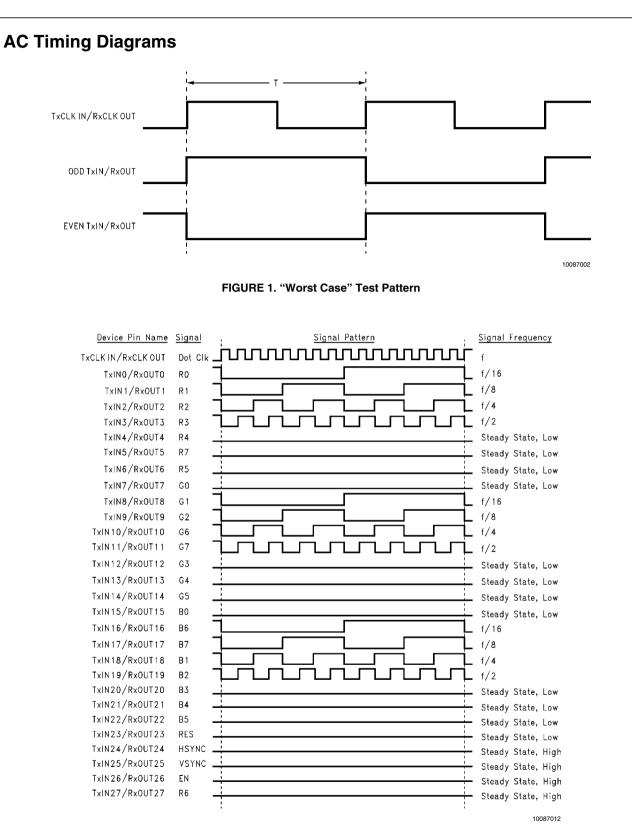
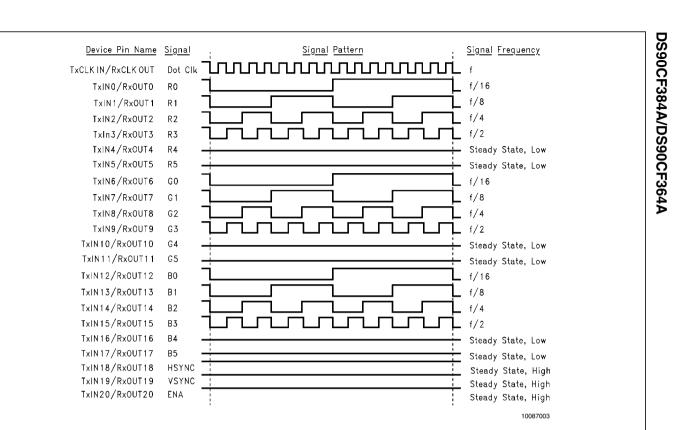


FIGURE 2. "16 Grayscale" Test Pattern (DS90CF384A)(Notes 5, 6, 7, 8)





Note 5: The worst case test pattern produces a maximum toggling of digital circuits, LVDS I/O and CMOS/TTL I/O.

Note 6: The 16 grayscale test pattern tests device power consumption for a "typical" LCD display pattern. The test pattern approximates signal switching needed to produce groups of 16 vertical stripes across the display.

Note 7: Figures 1, 3 show a falling edge data strobe (TxCLK IN/RxCLK OUT).

Note 8: Recommended pin to signal mapping. Customer may choose to define differently.

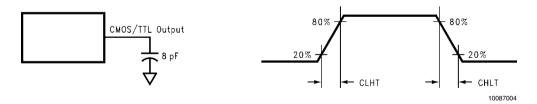
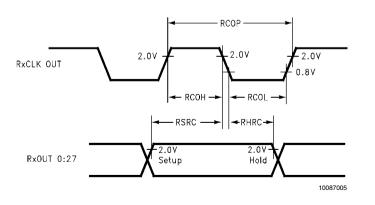
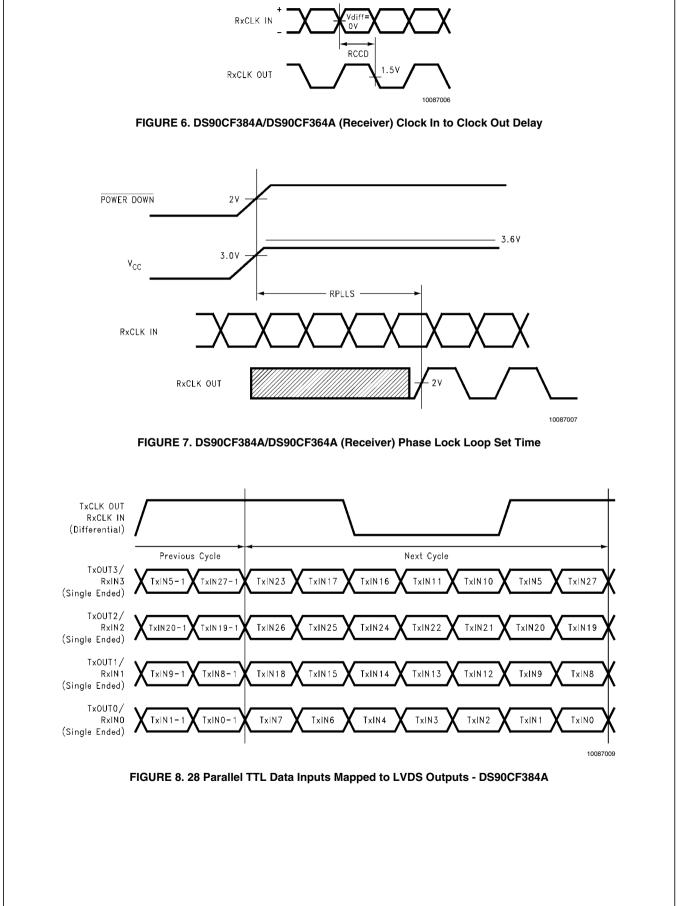


FIGURE 4. DS90CF384A/DS90CF364A (Receiver) CMOS/TTL Output Load and Transition Times









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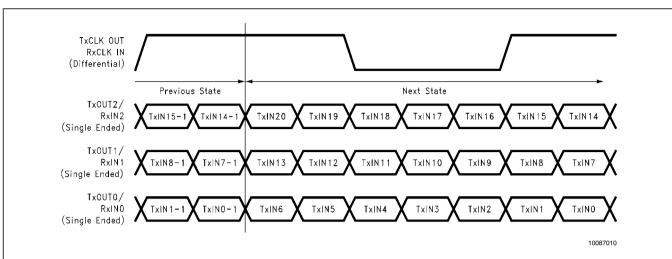


FIGURE 9. 21 Parallel TTL Data Inputs Mapped to LVDS Outputs - DS90CF364A

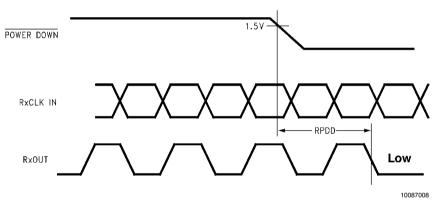
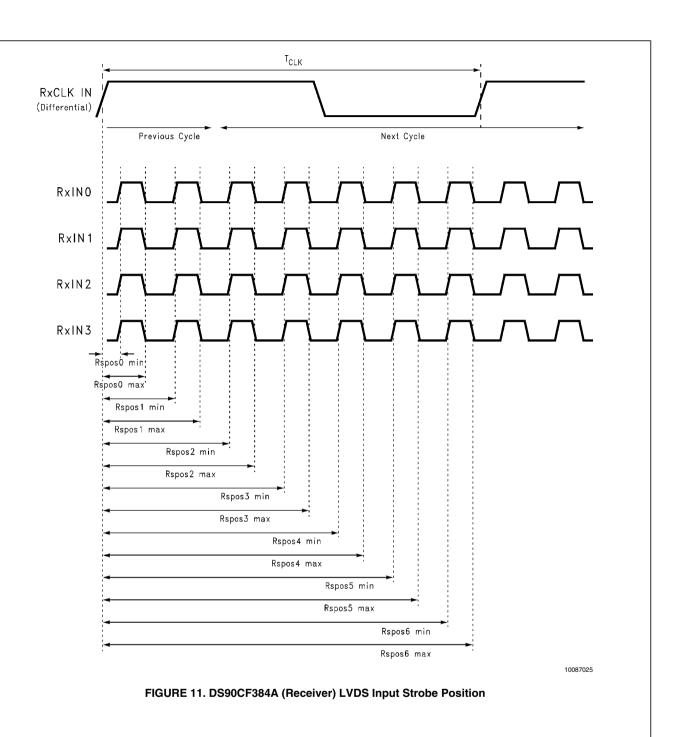


FIGURE 10. DS90CF384A/DS90CF364A (Receiver) Power Down Delay

DS90CF384A/DS90CF364A





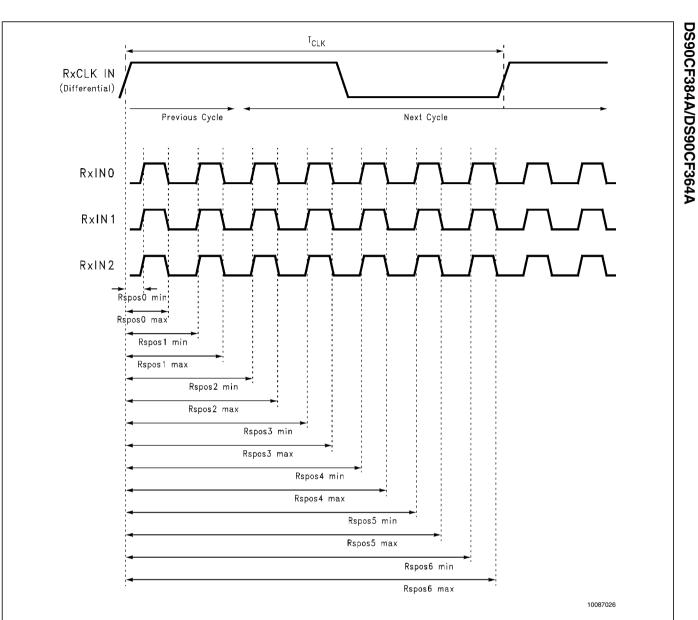
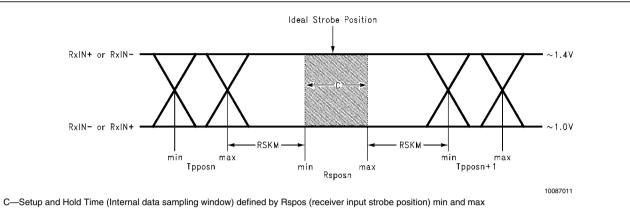


FIGURE 12. DS90CF364A (Receiver) LVDS Input Strobe Position



C—Setup and Hold Time (Internal data sampling window) defined by I Tppos—Transmitter output pulse position (min and max)

RSKM = Cable Skew (type, length) + Source Clock Jitter (cycle to cycle) + ISI (Inter-symbol interference)

Cable Skew-typically 10 ps-40 ps per foot, media dependent

Note 9: Cycle-to-cycle jitter is less than 250 ps at 65 MHz.

Note 10: ISI is dependent on interconnect length; may be zero.

FIGURE 13. Receiver LVDS Input Skew Margin

DS90CF384A Pin Descriptions — 56L TSSOP Package — 24-Bit FPD Link Receiver

| Pin Name | I/O | No. | Description |
|----------------------|-----|-----|---|
| RxIN+ | 1 | 4 | Positive LVDS differential data inputs. |
| RxIN- | 1 | 4 | Negative LVDS differential data inputs. |
| RxOUT | 0 | 28 | TTL level data outputs. This includes: 8 Red, 8 Green, 8 Blue, and 3 control lines—FPLINE, FPFRAME, DRDY (also referred to as HSYNC, VSYNC, Data Enable). |
| RxCLK IN+ | 1 | 1 | Positive LVDS differential clock input. |
| RxCLK IN- | 1 | 1 | Negative LVDS differential clock input. |
| RxCLK OUT | 0 | 1 | TTL level clock output. The falling edge acts as data strobe. |
| PWR DOWN | 1 | 1 | TTL level input. When asserted (low input) the receiver outputs are low. |
| V _{cc} | 1 | 4 | Power supply pins for TTL outputs. |
| GND | 1 | 5 | Ground pins for TTL outputs. |
| PLL V _{CC} | 1 | 1 | Power supply for PLL. |
| PLL GND | | 2 | Ground pin for PLL. |
| LVDS V _{CC} | 1 | 1 | Power supply pin for LVDS inputs. |
| LVDS GND | | 3 | Ground pins for LVDS inputs. |

DS90CF364A Pin Descriptions — 48L TSSOP Package — 18-Bit FPD Link Receiver

| Pin Name | I/O | No. | Description |
|----------------------|-----|-----|---|
| RxIN+ | 1 | 3 | Positive LVDS differential data inputs. |
| RxIN- | 1 | 3 | Negative LVDS differential data inputs. |
| RxOUT | 0 | 21 | TTL level data outputs. This includes: 6 Red, 6 Green, 6 Blue, and 3 control lines—FPLINE, FPFRAME, DRDY (also referred to as HSYNC, VSYNC, Data Enable). |
| RxCLK IN+ | 1 | 1 | Positive LVDS differential clock input. |
| RxCLK IN- | 1 | 1 | Negative LVDS differential clock input. |
| RxCLK OUT | 0 | 1 | TTL level clock output. The falling edge acts as data strobe. |
| PWR DOWN | 1 | 1 | TTL level input. When asserted (low input) the receiver outputs are low. |
| V _{CC} | 1 | 4 | Power supply pins for TTL outputs. |
| GND | 1 | 5 | Ground pins for TTL outputs. |
| PLL V _{CC} | 1 | 1 | Power supply for PLL. |
| PLL GND | 1 | 2 | Ground pin for PLL. |
| LVDS V _{CC} | | 1 | Power supply pin for LVDS inputs. |
| LVDS GND | 1 | 3 | Ground pins for LVDS inputs. |

DS90CF384A Pin Summary — 64 ball FBGA Package — FPD Link Receiver

| Pin Name | I/O | No. | Description |
|----------------------|-----|-----|---|
| RxIN+ | 1 | 4 | Positive LVDS differential data inputs. |
| RxIN- | 1 | 4 | Negative LVDS differential data inputs. |
| RxOUT | 0 | 28 | TTL level data outputs. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines—FPLINE, FPFRAME, DRDY (also referred to as HSYNC, VSYNC, Data Enable). |
| RxCLK IN+ | 1 | 1 | Positive LVDS differential clock input. |
| RxCLK IN- | 1 | 1 | Negative LVDS differential clock input. |
| RxCLK OUT | 0 | 1 | TTL level clock output. The falling edge acts as data strobe. Also known as FPSHIFT OUT |
| PWR DOWN | I | 1 | TTL level input. When asserted (low input) the receiver outputs are low. |
| V _{cc} | I | 4 | Power supply pins for TTL outputs. |
| GND | 1 | 5 | Ground pins for TTL outputs. |
| PLL V _{CC} | I | 1 | Power supply for PLL. |
| PLL GND | 1 | 2 | Ground pin for PLL. |
| LVDS V _{CC} | I | 1 | Power supply pin for LVDS inputs. |
| LVDS GND | I | 3 | Ground pins for LVDS inputs. |
| NC | | 6 | Pins not connected. |

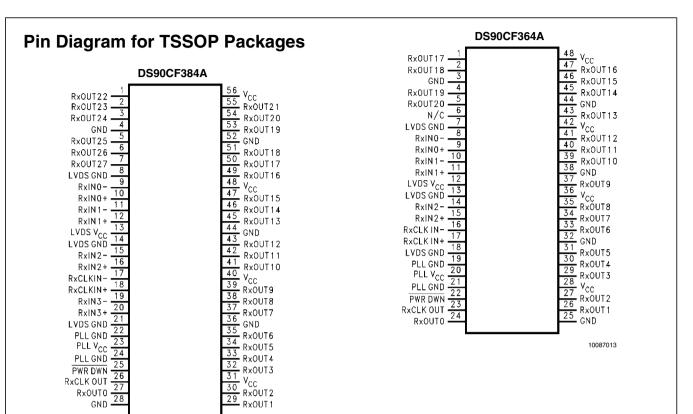
DS90CF384A Pin Descriptions — 64 ball FBGA Package — FPD Link Receiver

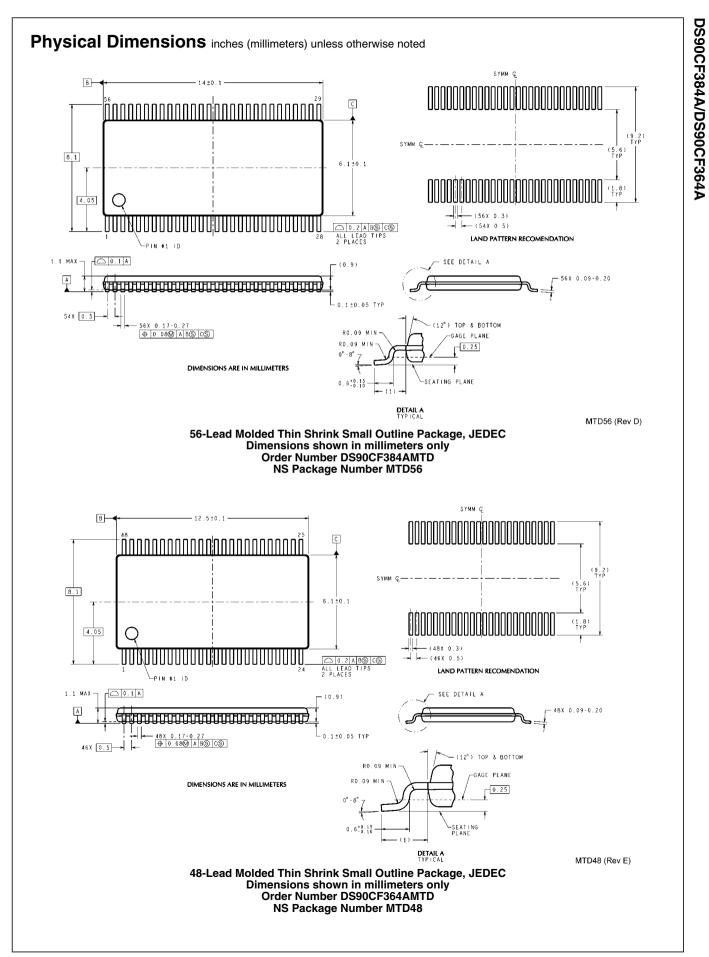
| | By Pin | | | By Pin Type | |
|-----|----------|------|-----|-------------|------|
| Pin | Pin Name | Туре | Pin | Pin Name | Туре |
| A1 | RxOUT17 | 0 | A4 | GND | G |
| A2 | VCC | Р | B1 | GND | G |
| A3 | RxOUT15 | 0 | B6 | GND | G |
| A4 | GND | G | D8 | GND | G |
| A5 | RxOUT12 | 0 | E3 | GND | G |
| A6 | RxOUT8 | 0 | E5 | LVDS GND | G |
| A7 | RxOUT7 | 0 | G3 | LVDS GND | G |
| A8 | RxOUT6 | 0 | G7 | LVDS GND | G |
| B1 | GND | G | H5 | LVDS GND | G |
| B2 | NC | | F6 | PLL GND | G |
| B3 | RxOUT16 | 0 | G8 | PLL GND | G |
| B4 | RxOUT11 | 0 | E6 | PWR DWN | I |
| B5 | VCC | Р | H6 | RxCLKIN- | I |
| B6 | GND | G | H7 | RxCLKIN+ | I |
| B7 | RxOUT5 | 0 | H2 | RxIN0- | I |
| B8 | RxOUT3 | 0 | H3 | RxIN0+ | I |
| C1 | RxOUT21 | 0 | F4 | RxIN1- | I |
| C2 | NC | | G4 | RxIN1+ | I |
| C3 | RxOUT18 | 0 | G5 | RxIN2- | I |
| C4 | RxOUT14 | 0 | F5 | RxIN2+ | I |
| C5 | RxOUT9 | 0 | G6 | RxIN3- | I |
| C6 | RxOUT4 | 0 | H8 | RxIN3+ | I |
| C7 | NC | | E7 | RxCLKOUT | 0 |
| C8 | RxOUT1 | 0 | E8 | RxOUT0 | 0 |
| D1 | VCC | Р | C8 | RxOUT1 | 0 |
| D2 | RxOUT20 | 0 | D5 | RxOUT10 | 0 |

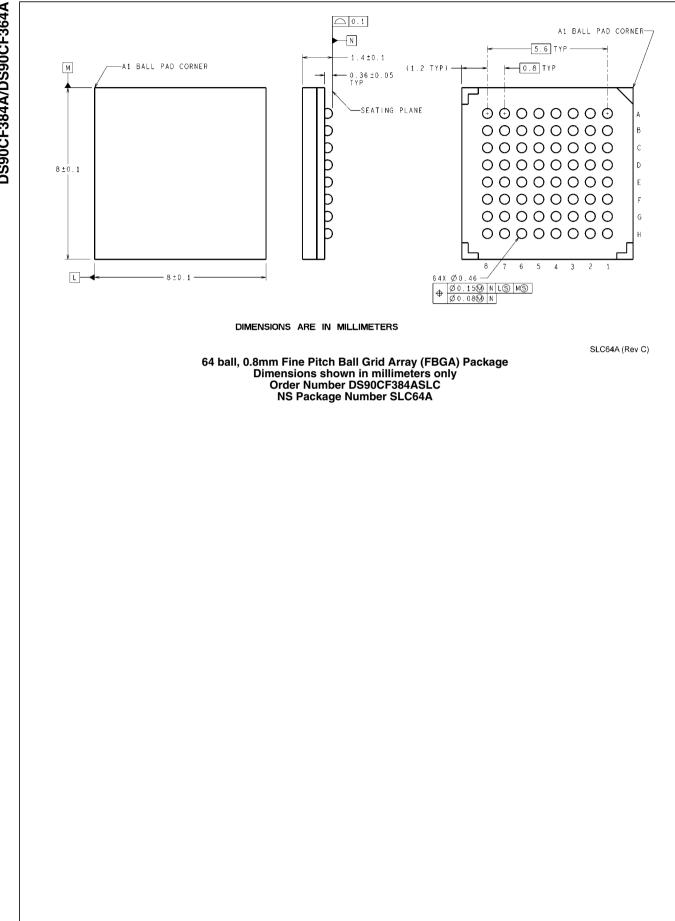
| | By Pin | | | By Pin Type | |
|----|----------|---|----|-------------|---|
| D3 | RxOUT19 | 0 | B4 | RxOUT11 | 0 |
| D4 | RxOUT13 | 0 | A5 | RxOUT12 | 0 |
| D5 | RxOUT10 | 0 | D4 | RxOUT13 | 0 |
| D6 | VCC | Р | C4 | RxOUT14 | 0 |
| D7 | RxOUT2 | 0 | A3 | RxOUT15 | 0 |
| D8 | GND | G | B3 | RxOUT16 | 0 |
| E1 | RxOUT22 | 0 | A1 | RxOUT17 | 0 |
| E2 | RxOUT24 | 0 | C3 | RxOUT18 | 0 |
| E3 | GND | G | D3 | RxOUT19 | 0 |
| E4 | LVDS VCC | Р | D7 | RxOUT2 | 0 |
| E5 | LVDS GND | G | D2 | RxOUT20 | 0 |
| E6 | PWR DWN | I | C1 | RxOUT21 | 0 |
| E7 | RxCLKOUT | 0 | E1 | RxOUT22 | 0 |
| E8 | RxOUT0 | 0 | F1 | RxOUT23 | 0 |
| F1 | RxOUT23 | 0 | E2 | RxOUT24 | 0 |
| F2 | RxOUT26 | 0 | G1 | RxOUT25 | 0 |
| F3 | NC | | F2 | RxOUT26 | 0 |
| F4 | RxIN1- | 1 | H1 | RxOUT27 | 0 |
| F5 | RxIN2+ | 1 | B8 | RxOUT3 | 0 |
| F6 | PLL GND | G | C6 | RxOUT4 | 0 |
| F7 | PLL VCC | Р | B7 | RxOUT5 | 0 |
| F8 | NC | | A8 | RxOUT6 | 0 |
| G1 | RxOUT25 | 0 | A7 | RxOUT7 | 0 |
| G2 | NC | | A6 | RxOUT8 | 0 |
| G3 | LVDS GND | G | C5 | RxOUT9 | 0 |
| G4 | RxIN1+ | I | E4 | LVDS VCC | Р |
| G5 | RxIN2- | 1 | H4 | LVDS VCC | Р |
| G6 | RxIN3- | I | F7 | PLL VCC | Р |
| G7 | LVDS GND | G | A2 | VCC | Р |
| G8 | PLL GND | G | B5 | VCC | Р |
| H1 | RxOUT27 | 0 | D1 | VCC | Р |
| H2 | RxIN0- | I | D6 | VCC | Р |
| H3 | RxIN0+ | I | B2 | NC | |
| H4 | LVDS VCC | Р | C2 | NC | |
| H5 | LVDS GND | G | C7 | NC | |
| H6 | RxCLKIN- | I | F3 | NC | |
| H7 | RxCLKIN+ | 1 | F8 | NC | |
| H8 | RxIN3+ | I | G2 | NC | |
| | | | | | |

G: Ground I : Input O: Output P: Power NC: Not connectted









DS90CF384A/DS90CF364A Notes

Notes

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 National Semiconductor
 National Semiconductor Europe

 Americas Customer
 Customer Support Center

 Support Center
 Fax: +49 (0) 180-530-85-86

 Email:
 Email: europe.support@nsc.com

 new.feedback@nsc.com
 Deutsch Tel: +49 (0) 69 9508 6208

 Tel: 1-800-272-9959
 English Tel: +49 (0) 870 24 0 2171

 Français Tel: +43 (0) 14 91 8790
 Français Tel: +33 (0) 14 191 8790

enter Pacific Cus 85-86 Email: ap.su @ nsc.com 99 508 6208

National Semiconductor Asia Pacific Customer Support Center Email: ap.support@nsc.com National Semiconductor Japan Customer Support Center Fax: 81-3-5639-7507 Email: jpn.feedback@nsc.com Tel: 81-3-5639-7560